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In re the Application of

JAN 24 2005

Applicant Cetin Kaya, et al.

Docket Number: TI-24995.1

Serial No.: 10/675,167

Art Unit: 2822

Filed: 09/30/03

Examiner: Michael M. Trinh

For: Scalable Dielectric

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NAME OF INVENTOR(S): Cetin Kaya, et al.	
TITLE OF INVENTION: Scalable Dielectric	
TI FILE NO.: TI-24995.1	DEPOSIT ACCT. NO.: 20-0668
FAXED: 1-24-05 DUE: 12-29-04 ATTY/SECY: RAK/kjv	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/675,167 Filing Date: 09/30/03	

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